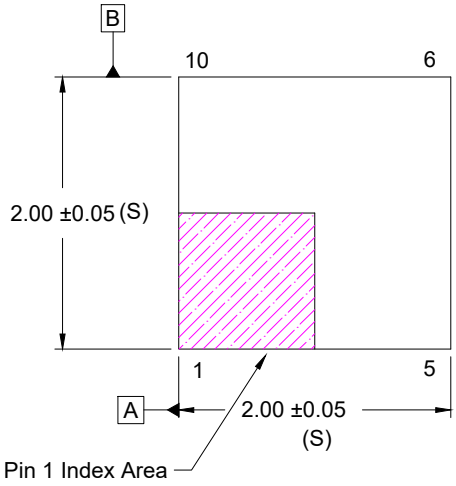
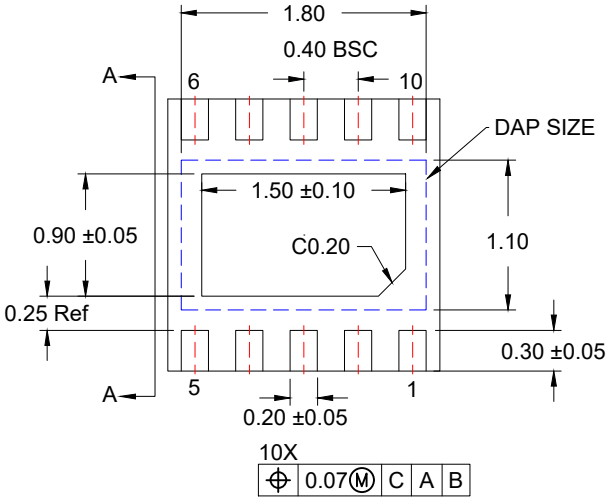
Package Outline Drawing

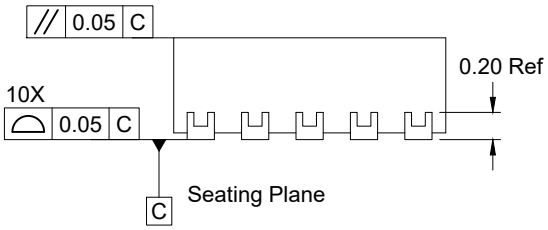
Package Code:NTG10P1
10-VFQFPN 2.0 x 2.0 x 0.75 mm Body, 0.4mm Pitch
PSC-4612-01, Revision: 00, Date Created: Jun 15, 2022



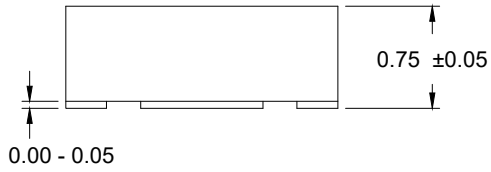
TOP VIEW



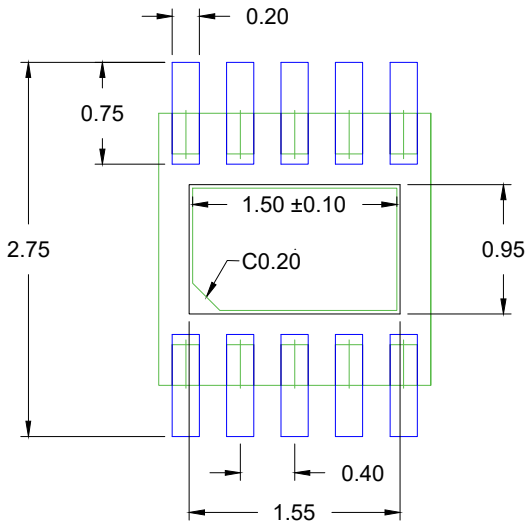
BOTTOM VIEW



SIDE VIEW



VIEW A - A



RECOMMENDED LAND PATTERN
(PCB Top View, NSMD Design)

NOTES:

1. All dimensions are in mm and angles are in degrees.
2. Top down view as viewed on PCB.
3. Component outline is shown for reference in green.
4. Land pattern in blue. NSMD pattern assumed.
5. Land pattern recommendation per IPC-7351B generic requirement for surface mount design and land pattern.

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